



Half-Bridge N-Channel MOSFET Driver With Break-Before-Make

FEATURES

- 5-V Gate Drive
- Undervoltage Lockout
- Sub 1- Ω Gate Drivers
- Internal Bootstrap Diode
- Drive MOSFETs In 4.5- to 30-V Systems
- Switching Frequency: 250 kHz to 1 MHz
- Synchronous Enable/Disable Option

APPLICATIONS

- Multi-Phase DC/DC
- High Current Synchronous Buck Converters
- High Frequency Synchronous Buck Converters
- Asynchronous-to-Synchronous Adaptations
- Mobile Computer DC/DC Converters
- Desktop Computer DC/DC Converters

DESCRIPTION

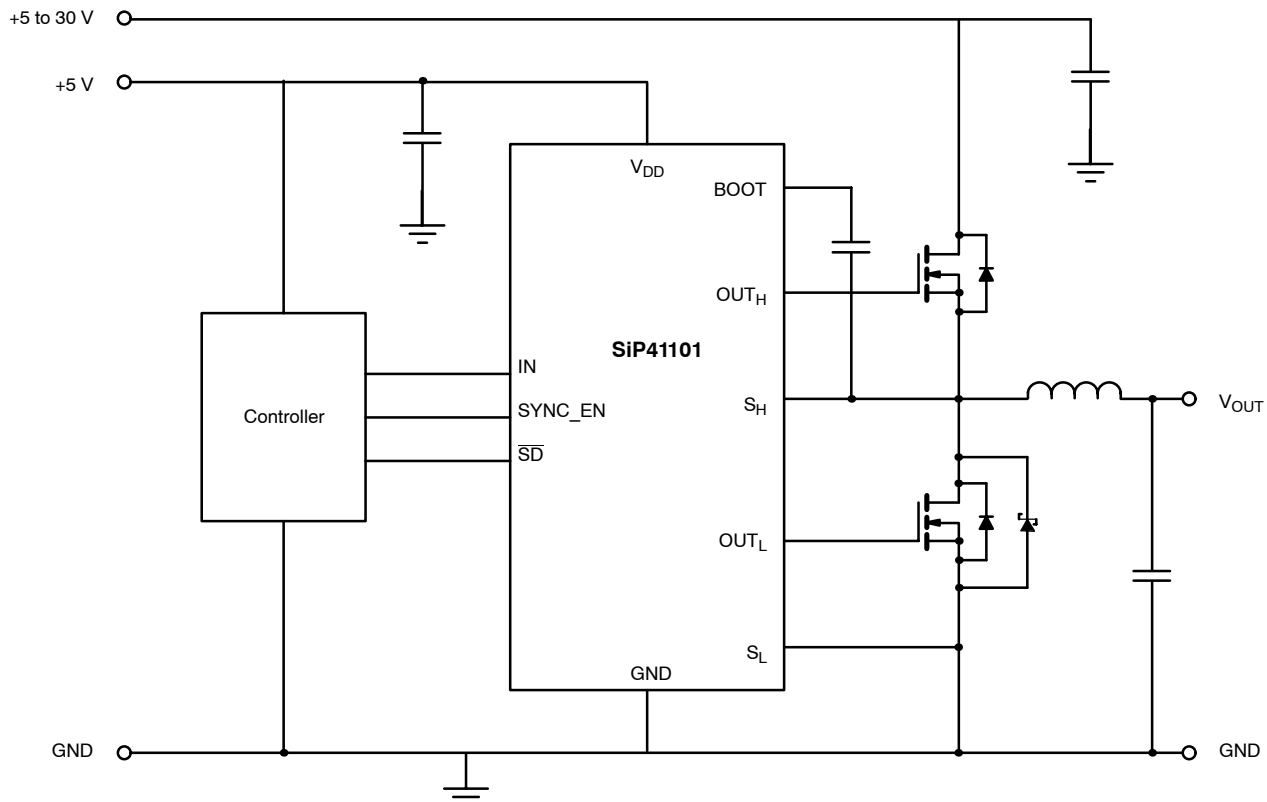
The SiP41101 is a high speed half-bridge driver, with make-before-break, for use in high frequency, high current multiphase dc-to-dc power supplies for supply voltages as high as 30 V. It is designed to operate at frequencies up to 1 MHz. The high-side driver is bootstrapped to allow driving an n-channel high-side MOSFET. The bootstrap diode is internal. The output drivers provide currents up to 4 A, allowing use of low $r_{DS(on)}$ power MOSFETs.

MOSFETs. The $\overline{SD}$ control pin is provided to enable the drivers. A Synchronous Enable control pin is provided to disable the the low-side or synchronous MOSFET to maximize efficiency under low output current conditions.

The SiP41101 is available in a 16-pin TSSOP package for operation over the industrial temperature range of -40 to 85°C.

The SiP41101 comes with internal break-before-make circuitry to prevent shoot-through current in the external

TYPICAL APPLICATION DIAGRAM



**ABSOLUTE MAXIMUM RATINGS (ALL VOLTAGES REFERENCED TO GND = 0 V)**

V_{DD}	7 V
V_{IN}	-0.3 V to $V_{DD} + 0.3$ V
V_{SH}	30 V
V_{BOOT}	$V_{SH} + 7$ V
Storage Temperature	-40 to 150°C
Operating Junction Temperature	125°C

Power Dissipation ^a	
TSSOP-16	925 mW
Thermal Impedance (Θ_{JA}) _a	
TSSOP-16	135°C/W
Notes	
a. Device mounted with all leads soldered or welded to PC board.	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE (ALL VOLTAGES REFERENCED TO GND = 0 V)

V_{DD}	4.5 V to 5.5 V
V_{BOOT}	4.5 V to 30 V

C_{BOOT}	100 nF to 1 μ F
Operating Temperature Range	-40 to 85°C

SPECIFICATIONS^a

Parameter	Symbol	Test Conditions Unless Specified V _{DD} = 4.5 to 5.5 V, V _{BOOT} = 4.5 to 30 V, T _A = -40 to 85°C	Limits			Unit
			Min ^a	Typ ^b	Max ^a	
Power Supplies						
Supply Voltage	V _{DD}		4.5		5.5	V
Supply Current	I _{DD}	f _{IN} = 300 kHz, $\overline{SD}$ = H, Sync_en = H see Figure 1		25	40	mA
Quiescent Current	I _{DDQ}	IN = L, $\overline{SD}$ = H, Sync_en = H, No Load		1.4	2.5	μA
Reference Voltage						
Break-Before-Make	V _{BBM}	V _{DD} = 5.5 V		2.5		V
Logic Inputs — IN, Sync En, $\overline{SD}$						
Input High	V _{IH}		2.5			V
Input Low	V _{IL}				1.0	
Undervoltage Lockout						
V _{DD} Undervoltage	V _{UVL}	V _{DD} Rising	2.5	3.6	4.4	V
Undervoltage Hysteresis	V _{HYST}			400		mV
Bootstrap Diode						
Forward Voltage	V _F	I _F = 10 mA		0.65		V
MOSFET Drivers						
High-Side Drive Current ^c	I _{PKH} (source)	V _{BOOT} - V _{SH} = 4.5 V, V _{OUTH} -V _{SA} =2.25V		3.0		A
	I _{PKH} (sink)			3.0		
Low-Side Drive Current ^c	I _{PKL} (source)	V _{DD} = 4.5 V, V _{OUTL} =2.25V		4.1		
	I _{PKL} (sink)			4.1		
High-Side Driver Impedance	R _{DH} (source)	V _{DD} = 4.5 V, S _H = GND		0.75	1.3	Ω
	R _{DH} (sink)			0.75	1.3	
Low-Side Driver Impedance	R _{DL} (source)	V _{DD} = 4.5 V		0.55	1.1	
	R _{DL} (sink)			0.55	1.1	

**SPECIFICATIONS^a**

Parameter	Symbol	Test Conditions Unless Specified $V_{DD} = 4.5$ to 5.5 V, $V_{BOOT} = 4.5$ to 30 V, $T_A = -40$ to 85°C	Limits			Unit
			Min ^a	Typ ^b	Max ^a	
MOSFET Drivers						
High-Side Rise Time ^c	t_{rH}	10% - 90%		15		ns
High-Side Fall Time ^c	t_{fH}	90% - 10%		15		
High-Side Propagation Delay ^c	$t_{d(off)H}$	50% - 50%		25		
	Δt_{H-L}			5		
Low-Side Rise Time ^c	t_{rL}	10% - 90%		25		
Low-Side Fall Time ^c	t_{fL}	90% - 10%		15		
Low-Side Propagation Delay ^c	$t_{d(off)L}$	50% - 50%		10		
	Δt_{L-H}			25		

Notes

- a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum (-40° to 85°C).
b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
c. Guaranteed by design.

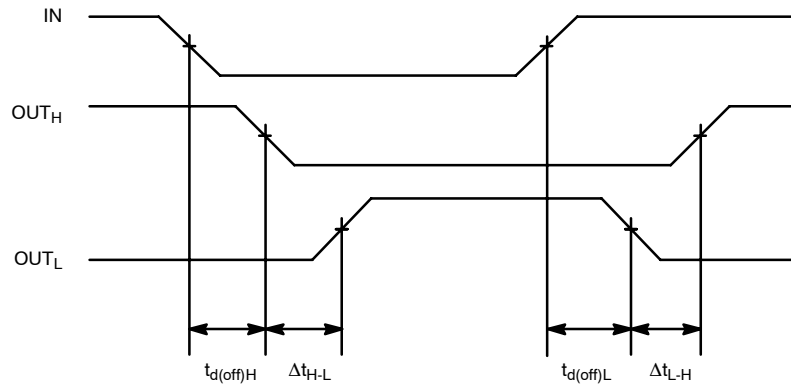
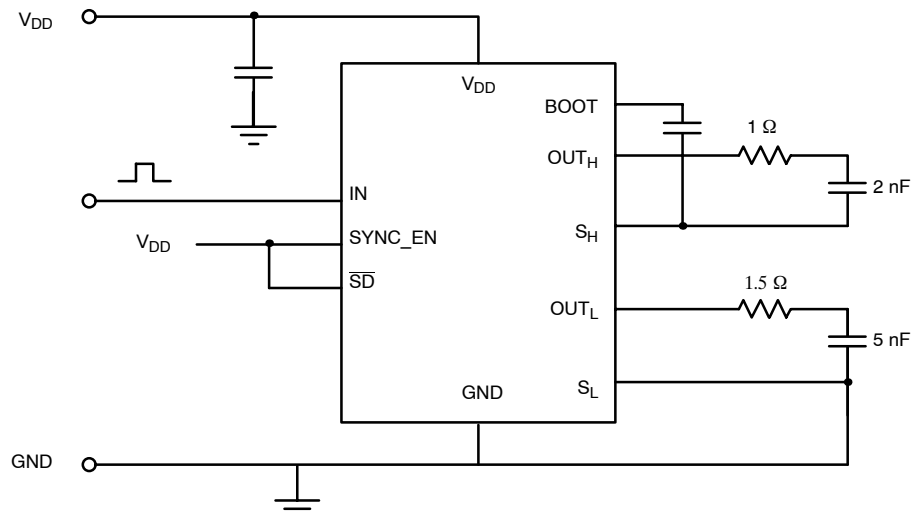
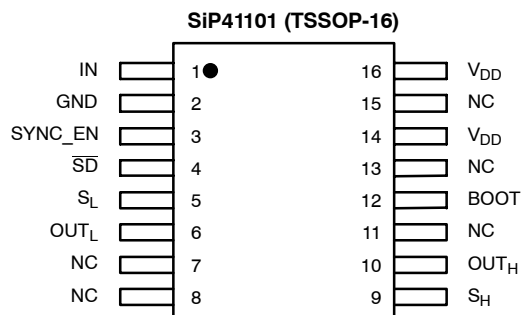
TIMING WAVEFORMS**TEST SETUP**

Figure 1.

PIN CONFIGURATION, ORDERING INFORMATION, AND TRUTH TABLE



Top View

ORDERING INFORMATION

Part Number	Temperature Range	Marking
SiP41101DQ-T1	-40 to 85°C	41101

Eval Kit	Temperature Range
SiP41101DB	-40 to 85°C

TRUTH TABLE

$\overline{SD}$	SYNC_EN	IN	OUT _H	OUT _L
H	H	L	L	H
H	H	H	H	L
H	L	L	L	L
H	L	H	H	L
L	X	X	L	L

PIN DESCRIPTION

Pin	Name	Function
1	IN	Input signal to the MOSFET drivers
2	GND	Ground
3	SYNC_EN	Synchronous MOSFET enable
4	$\overline{SD}$	Shutdown
5	S _L	Connection to source of low-side MOSFET
6	OUT _L	Synchronous or low-side MOSFET gate drive
7, 8, 11, 13, 15	NC	No Connect
9	S _H	Connection to source of high-side MOSFET
10	OUT _H	Control or high-side MOSFET gate drive
12	BOOT	Connection for the bootstrap capacitor
14, 16	V _{DD}	+5-V supply

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TYPICAL WAVEFORMS

